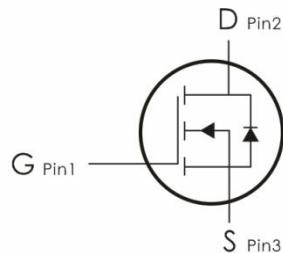
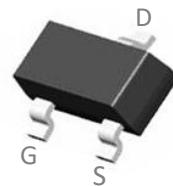


Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.



Features:

- 1) $V_{DS}=20V, I_D=3.0\text{ A}, R_{DS(on)}<42\text{ m}\Omega @ V_{GS}=4.5\text{ V}$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra $R_{DS(on)}$.
- 5) Excellent package for good heat dissipation.

Absolute Maximum Ratings: ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 10	V
I_D	Continuous Drain Current- $T_A=25^\circ\text{C}$	3.0	A
I_{DM}	Pulse Drain Current Tested	14	A
P_D	Power Dissipation- $T_A=25^\circ\text{C}$	0.7	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{\Theta JA}$	Thermal Resistance,Junction to Ambient	178	$^\circ\text{C}/\text{W}$

Package Marking and Ordering Information:

Part NO.	Marking	Package
DO2302D-Q	2302D	SOT-23

Electrical Characteristics: ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	20	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=20\text{V}$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 10\text{V}, V_{\text{DS}}=0\text{A}$	---	---	± 100	nA
On Characteristics						
$V_{\text{GS}(\text{th})}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	0.55	0.78	1.1	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-Resistance	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=3\text{A}$	---	32	42	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=2\text{A}$	---	42	60	
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	220	---	pF
C_{oss}	Output Capacitance		---	34	---	
C_{rss}	Reverse Transfer Capacitance		---	26	---	
Switching Characteristics						
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=10\text{V}, R_{\text{L}}=1.5\Omega, R_{\text{G}}=3\Omega$	---	6.8	---	ns
t_r	Rise Time		---	57	---	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	14	---	ns
t_f	Fall Time		---	53	---	ns
Q_g	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=10\text{V}, I_{\text{D}}=3\text{A}$	---	3.61	---	nC
Q_{gs}	Gate-Source Charge		---	0.88	---	nC
Q_{gd}	Gate-Drain "Miller" Charge		---	0.77	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=3\text{A}$	---	---	1.2	V

Typical Characteristics: ($T_A=25^\circ\text{C}$ unless otherwise noted)

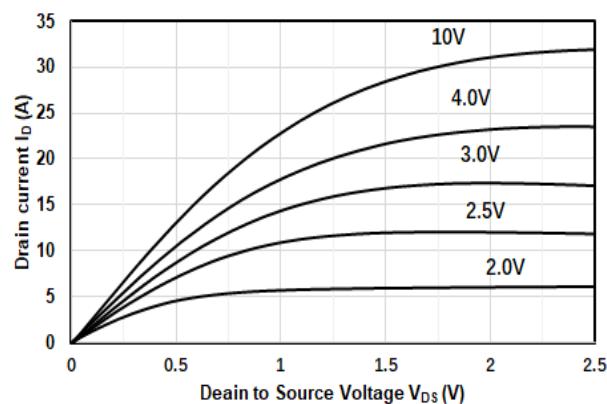


Figure1. Output Characteristics

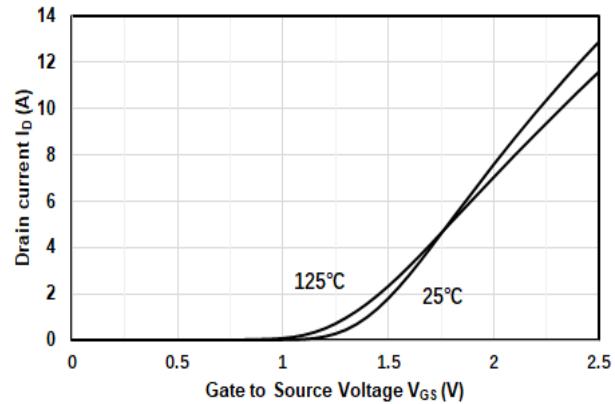


Figure2. Transfer Characteristics

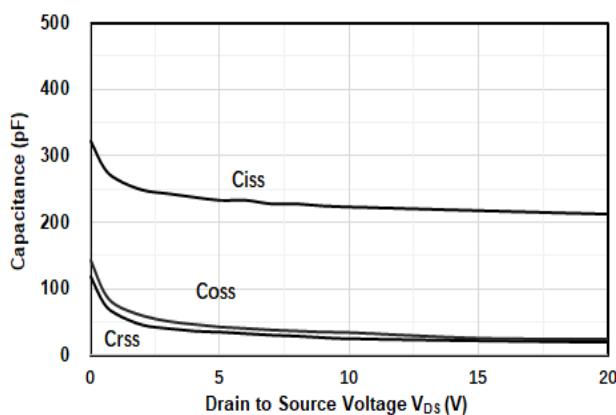


Figure3. Capacitance Characteristics

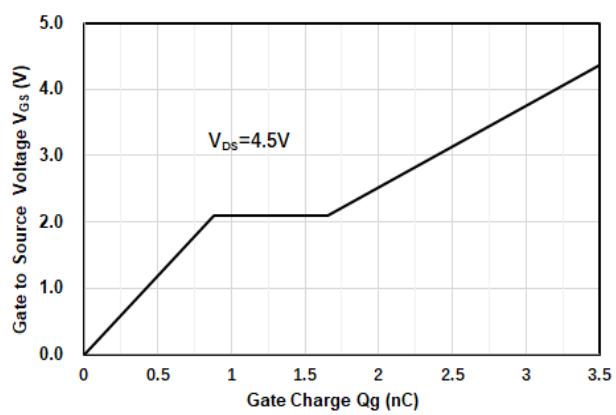


Figure4. Gate Charge

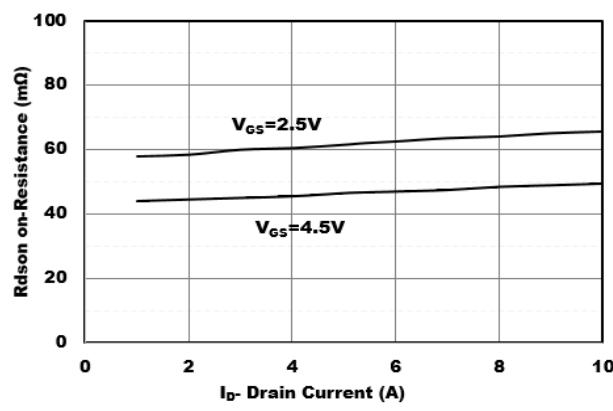


Figure5. Drain-Source on Resistance

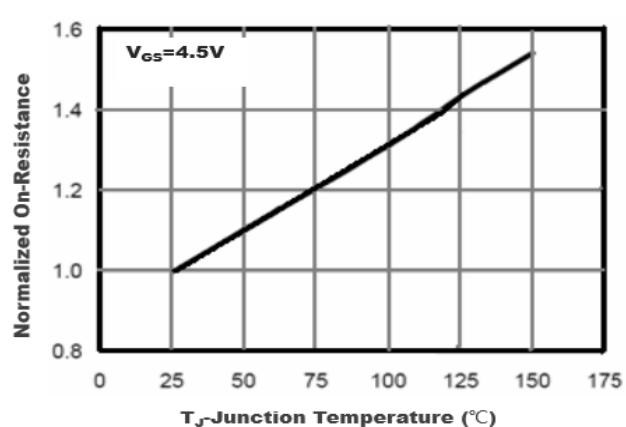


Figure6. Drain-Source on Resistance

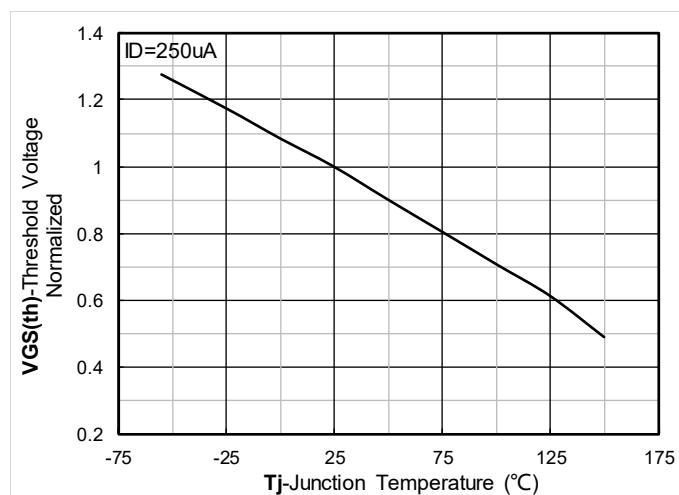
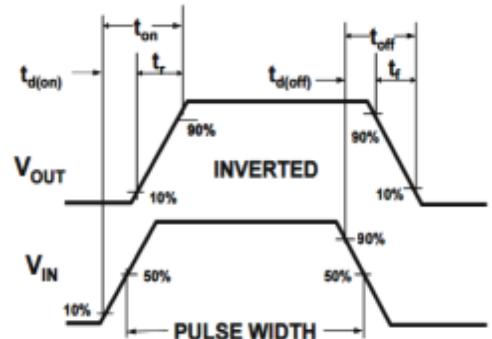
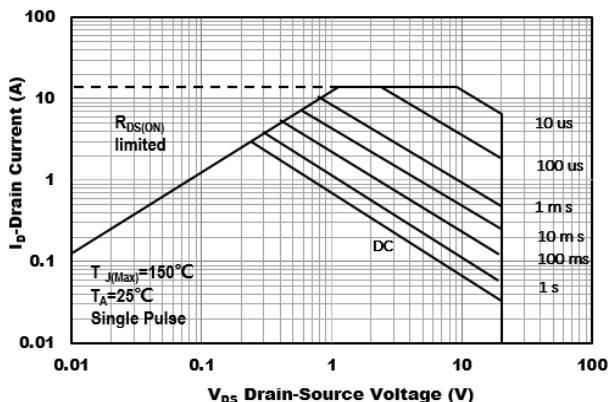


Figure 9. Normalized Threshold voltage